



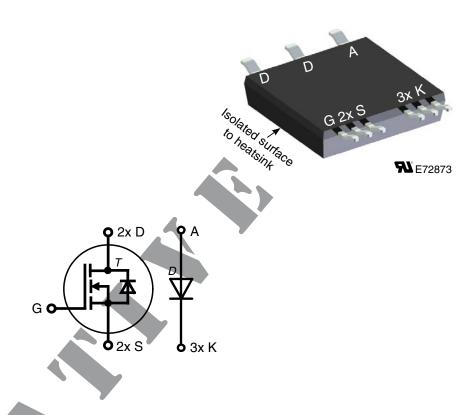
# **Buck / Boost Tpology**

CoolMOS<sup>TM 1)</sup> with fast SONIC Diode

I<sub>D25</sub> 54 A = 600 V $R_{DS(on) max} = 41 m\Omega$ 

**ISOPLUS™** - electrically isolated surface to heatsink **Surface Mount Power Device** 

Part number MKG40RK600LB



## Features / Advantages:

- Fast CoolMOS™ 1) C6 MOSFET
- very low on-resistance
- low gate charge
- avalanche rated for unclamped inductive switching (UIS)

## Applications:

- Buck / boost chopper
- PFC stage
- Forward converter

#### Package: SMPD

- isolated surface to heatsink
- low coupling capacity between pins and heatsink
- PCB space saving
- enlarged creepage towards heatsink
- application friendly pinout
- low inductive current path
- high reliability

1) CoolMOS™ is a trademark of Infineon Technologies AG.



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Data according ot IEC 60747 and per semiconductor unless otherwise specified



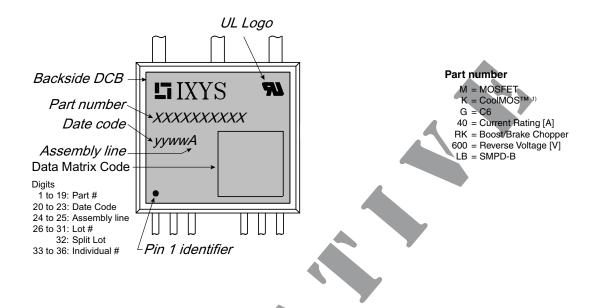
MOSFET					Rating	<b>S</b>		
Symbol	Definitions	Conditions		min.	typ.	max.		
$\mathbf{V}_{\mathtt{DSS}}$	drain source breakdown voltage	ир	to $T_{VJ} = 150^{\circ}C$			600	١	
$V_{GS}$	gate source voltage	continuous transient	$T_{VJ} = 25^{\circ}C$			±20 ±30	\	
I <sub>D25</sub>	drain current		$T_{\rm C} = 25^{\circ}{\rm C}$			54	A	
I <sub>D80</sub>			$T_C = 80^{\circ}C$			41	A	
I <sub>D100</sub>			$T_C = 100^{\circ}C$			34	A	
E <sub>AS</sub>	non-repetetive avalanche energy	single pulse	$T_{VJ} = 25^{\circ}C$			1.95 13.4	Ā	
dV/dt	rate of rise of voltage	$I_S \ge I_{DM}; V_{DD} \le 400 \text{ V}$	$T_{VJ} = 25^{\circ}C$			15	V/ns	
R <sub>DSon</sub>	static drain source on resistance	$I_D = 44 \text{ A}; V_{GS} = 10 \text{ V (Chip)}$	$T_{VJ} = 25^{\circ}C$		37	41	mΩ	
V <sub>GS(th)</sub>	gate threshold voltage	$I_D = 3 \text{ mA}; V_{DS} = V_{GS}$	$T_{VJ} = 25^{\circ}C$	2.5	3	3.5	\	
I <sub>DSS</sub>	drain source leakage current	$V_{DS} = V_{DSS}$ ; $V_{GS} = 0 \text{ V}$	$T_{VJ} = 25^{\circ}C$ $T_{VJ} = 150^{\circ}C$		50	5	μ <i>Α</i>	
I <sub>GSS</sub>	gate source leakage current	$V_{DS} = 0 \text{ V}; V_{GS} = \pm 20 \text{ V}$				±100	n/	
C <sub>iss</sub>	input capacitance	$V_{GS} = 0 \text{ V}; V_{DS} = 100 \text{ V}; f = 1 \text{ MHz}$	T <sub>v,j</sub> = 25°C		6.5		nF	
Coss	output capacitance		$T_{VJ} = 125^{\circ}C$		360		pF	
Q <sub>g</sub>	total gate charge	$V_{DS} = 480 \text{ V}; I_{D} = 44 \text{ A}$	_		290	190	nC	
$Q_{qs}$	gate source charge	$V_{DS} = 480 \text{ V}; I_D = 44 \text{ A}$ $V_{GS} = 10 \text{ V}; R_G = 1.6 \Omega$	$T_{VJ} = 25^{\circ}C$		36		nC	
$\mathbf{Q}_{gd}$	gate drain (Miller) charge	V <sub>GS</sub> = 10 V, H <sub>G</sub> = 1.0 12			150		nC	
$\mathbf{t}_{d(on)}$	turn-on delay time				tbd		ns	
t,	current rise time	Inductive switching			tbd		ns	
t <sub>d(off)</sub>	turn-off delay time	boost mode with diode D			tbd		ns	
t <sub>f</sub>	current fall time	$V_{DS} = 380 \text{ V}; I_D = 44 \text{ A}$	$T_{VJ} = 25^{\circ}C$		tbd		ns	
E <sub>on</sub>	turn-on energy per pulse	$V_{GS} = 13 \text{ V}; R_{G} = 1.6 \Omega$	•••		tbd		m.	
E <sub>off</sub>	turn-off energy per pulse				tbd		mJ	
E <sub>rec(off)</sub>	reverse recovery losses at turn-off				tbd		mJ	
R <sub>thJC</sub>	thermal resistance junction to case thermal resistance junction to heatsink	with hastoink compound IVVC to	ot ootun		0.6	0.4	K/W K/W	
R <sub>thJH</sub>	· ·	with heatsink compound; IXYS te	si seiup		0.6		r\/ vv	
	Orain Diode of MOSFETT				Rating:	1 :		
Symbol	Definitions	Conditions		min.	typ.	max.		
I <sub>S25</sub> I <sub>S80</sub>	continuous source current	<b>Y</b>	$T_{C} = 25^{\circ}C$ $T_{C} = 80^{\circ}C$			70 tbd	A	
V <sub>SD</sub>	forward voltage drop	$I_F = 44 \text{ A}; V_{GS} = 0 \text{ V}$	$T_{VJ} = 25^{\circ}C$		0.9	1.1	V	
t <sub>rr</sub>	reverse recovery time	$I_{\rm F} = 44 \text{ A}; V_{\rm B} = 400 \text{ V}$	T <sub>v,j</sub> = 25°C			950	ns	
$\mathbf{Q}_{RM}$	reverse recovery charge (intrinsic diode)	$v_{\rm F} = 44  \text{A}, v_{\rm R} = 400  \text{V}$ - $v_{\rm H} = 100  \text{A/µs}$	1 <sub>VJ</sub> = 25 O		32		μC	
I <sub>RM</sub>	max. reverse recovery current	ог/ at = 100 / V до			62		Α	
Diode D				Rating		js .		
Symbol	Definitions	Conditions		min.	typ.	max.		
V <sub>RRM</sub>	max. repetitive reverse voltage		$T_{VJ} = 25^{\circ}C$			600	٧	
I <sub>F25</sub>		DC	$T_C = 25^{\circ}C$			65	A	
I <sub>F80</sub>	continuous source current	DC	$T_{\rm C} = 80^{\circ}{\rm C}$			45	А	
V <sub>F</sub>	forward voltage	I <sub>F</sub> = 44 A (Chip)	$T_{VJ} = 25^{\circ}C$		1.70	2.0	٧	
<u> </u>			$T_{VJ}^{V3} = 125^{\circ}C$		1.65		V	
I <sub>R</sub>	reverse current	$V_R = V_{RRM}$	$T_{VJ} = 25^{\circ}C$ $T_{VJ} = 125^{\circ}C$			100 8	μA mA	
	max. reverse recovery current	I <sub>F</sub> = 30 A; V <sub>R</sub> = 350 V	T <sub>v,j</sub> = 100°C		tbd		Δ	
I <sub>RM</sub>	max. reverse receivery carrein		-5	1	I			
I <sub>RM</sub>	max. revalue recevery cameric	-di/dt = 240 A/µs				<u> </u>		
I <sub>RM</sub>	reverse recovery time	-di/dt = 240 A/ $\mu$ s $I_F = 1 A; V_R = 30 V; -di/dt = 100 A/dt$	$\mu s T_{VJ} = 100^{\circ}C$		tbd		ns	
		· · · · · · · · · · · · · · · · · · ·	μs T <sub>vJ</sub> = 100°C		tbd	0.6	ns K/W	

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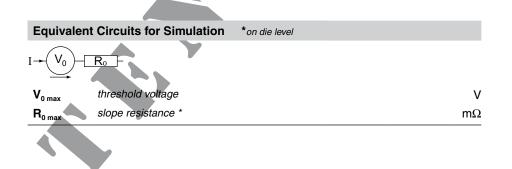
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Package SMPD				Ratings			
Symbol	Definitions	Conditions	min.	typ.	max.		
T <sub>stg</sub>	storage temperature virtual junction temperature		-55 -55		125 150	°C °C	
Weight				8		g	
F <sub>c</sub>	mounting force with clip		40		130	N	
d <sub>Spp/App</sub>	creepage distance on surface / striking distance through air	terminal to terminal terminal to backside	1.65 4.0			mm mm	
V <sub>ISOL</sub>	isolation voltage	$t = 1$ second $t = 1$ minute 50/60 Hz; RMS; $I_{ISOL} < 1$ mA		3000 2500		V	
C <sub>P</sub>	coupling capacity	between shorted terminals and backside metal		90		pF	
СТІ			400				
R <sub>pin-chip</sub>	resistance pin to chip	$V = (R_{DSon} + 2 \cdot R) \cdot I_D \text{ resp. } V = V_F + 2 \cdot R \cdot I_F$		1		mΩ	



Ordering	Part Name		Marking on Product	<b>Delivering Mode</b>	Base Qty	Ordering Code
Standard	MKG40RK600LB-TRR	V	MKG40RK600LB	Tape&Reel	200	514630





#### **Outlines SMPD**

